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Vishay/Siliconix SI4910DY-T1-E3

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Si4910DY

Vishay Siliconix

Dual N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	2) I _D (A) ^a			
40	0.027 at V _{GS} = 10 V	6.0	9.6		
	0.032 at V _{GS} = 4.5 V	4.8	9.0		

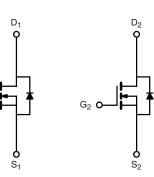
FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

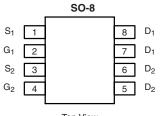
APPLICATIONS

CCFL Inverter

G







Top View

Ordering Information: Si4910DY-T1-E3 (Lead (Pb)-free) Si4910DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 28$	5 °C, unless othe	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 16		
	T _C = 25 °C		7.6		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I _D	6.0		
	T _A = 25 °C		6.0 ^{b, c}		
	T _A = 70 °C		4.8 ^{b, c}		
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	20	А	
Source-Drain Current Diode Current	T _C = 25 °C	- I _S	2.6	A	
Source-Drain Guirent Diode Guirent	T _A = 25 °C		1.6 ^{b, c}		
Pulsed Source-Drain Current		I _{SM}	20		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10	-	
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	5	1	
	T _C = 25 °C		3.1	W	
Maximum Bowar Dissinction	T _C = 70 °C	P _D	2		
Maximum Power Dissipation	T _A = 25 °C		2 ^{b, c}		
	T _A = 70 °C		1.28 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	49	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady-State	R _{thJF}	30	40	0/11	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 120 °C/W.



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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	-,	[[-76-			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			37		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.6		2.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 16 V$			100	nA	
, ,		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			A	
· · · · · · · · · ·		V _{GS} = 10 V, I _D = 6 A		0.022	0.027		
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.8 \text{ A}$		0.026	0.032	Ω	
Forward Transconductance ^b	g _{fs}	$V_{DS} = 15 \text{ V}, I_D = 6 \text{ A}$		20		S	
Dynamic ^a							
Input Capacitance	C _{iss}			855	[pF	
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, I _D = 1 MHz		105			
Reverse Transfer Capacitance	C _{rss}			65			
	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		21	32	nC	
Total Gate Charge				9.6	14.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		2.3			
Gate-Drain Charge	Q _{gd}			3.2			
Gate Resistance	Rg	f = 1 MHz		2.5	3.8	Ω	
Turn-On Delay Time	t _{d(on)}			6	12	-	
Rise Time	t _r	V_{DD} = 20 V, R_L = 4 Ω		11	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		24	36		
Fall Time	t _f			6	12		
Turn-On Delay Time	t _{d(on)}			12	20	- ns - -	
Rise Time	t _r	V_{DD} = 20 V, R_L =4 Ω		60	90		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong \text{5}$ A, V_GEN = 4.5 V, R_g = 1 Ω		22	33		
Fall Time	t _f			5	10		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			2.6	- A	
Pulse Diode Forward Current ^a	I _{SM}				20		
Body Diode Voltage	V _{SD}	I _S = 1.5 A		0.73	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			26	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		21	32	nC	
Reverse Recovery Fall Time	t _a	$T_F = 5 A$, u/u = 100 A/µs, $T_J = 25 C$		13			
Reverse Recovery Rise Time				13		ns	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



2.0

1.6

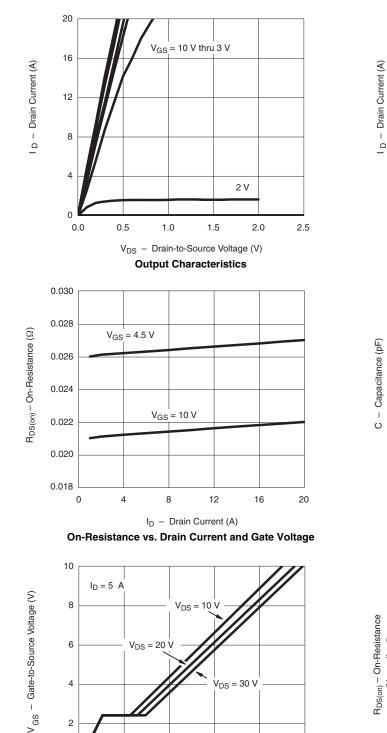
1.2

0.8



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/_{DS} = 30 V

17.6

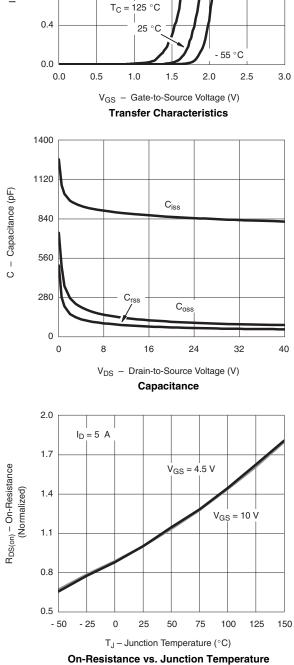
22.0

13.2

Qg - Total Gate Charge (nC)

Gate Charge

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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4

2

0

0.0

4.4

8.8

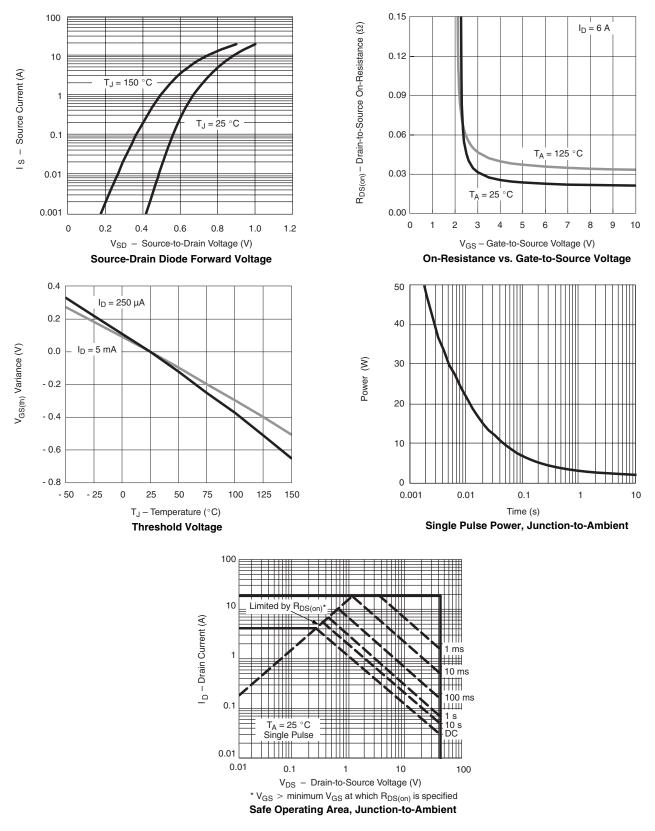


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



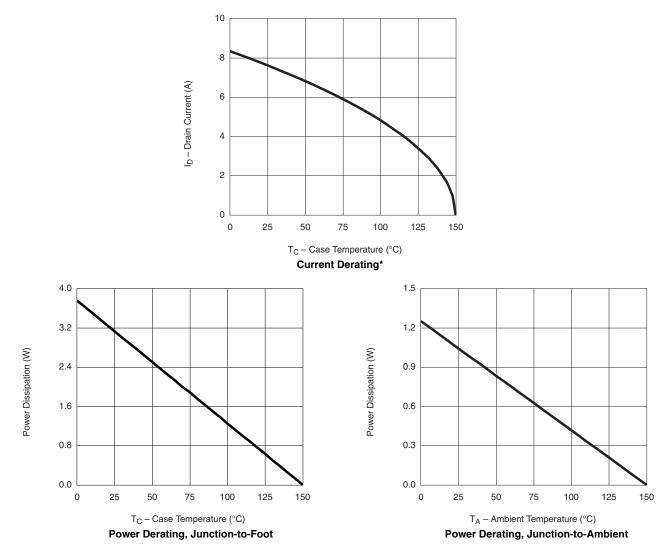




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

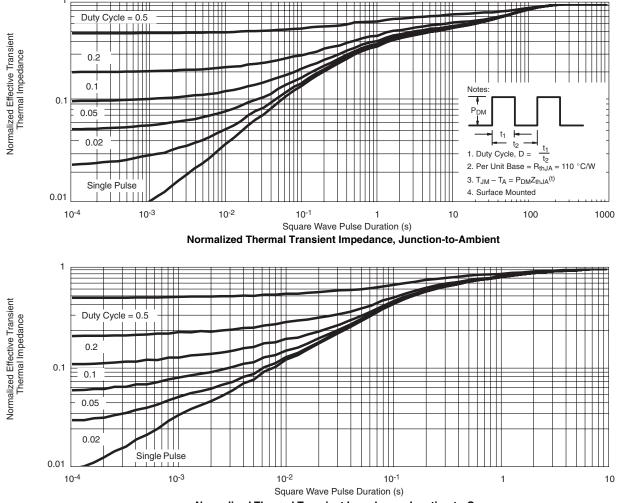


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Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73699.





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